

RF AMPLIFIER

MODEL *TM7275*

Available as: TM7275, 4 Pin TO-8 (T4)
 TN7275, 4 Pin Surface Mount (SM3)
 FP7275, 4 Pin Flatpack (FP4)
 BX7275, Connectorized Housing (H1)

Features

- High Gain: 20.5 dB Typical
- Low Noise Figure: <3.0 dB Typical
- Operating Temp. -55 °C to +85 °C
- Environmental Screening Available

Specifications

CHARACTERISTIC	TYPICAL Ta= 25 °C	MIN/MAX Ta = -55 °C to +85 °C
Frequency	5 - 250 MHz	5 - 250 MHz
Gain (dB)	20.5	19.0 Min.
Power @ 1 dB Comp. (dBm)	+9.5	+8.0 Min.
Reverse Isolation (dB)	-25	-22 Max.
VSWR In	<1.5:1	2.0:1 Max.
Out	<1.75:1	2.0:1 Max.
Noise figure (dB)	2.5	3.5 Max.
Power Vdc	+15	+15
mA	24	27 Max.

Note: Care should always be taken to effectively ground the case of each unit.

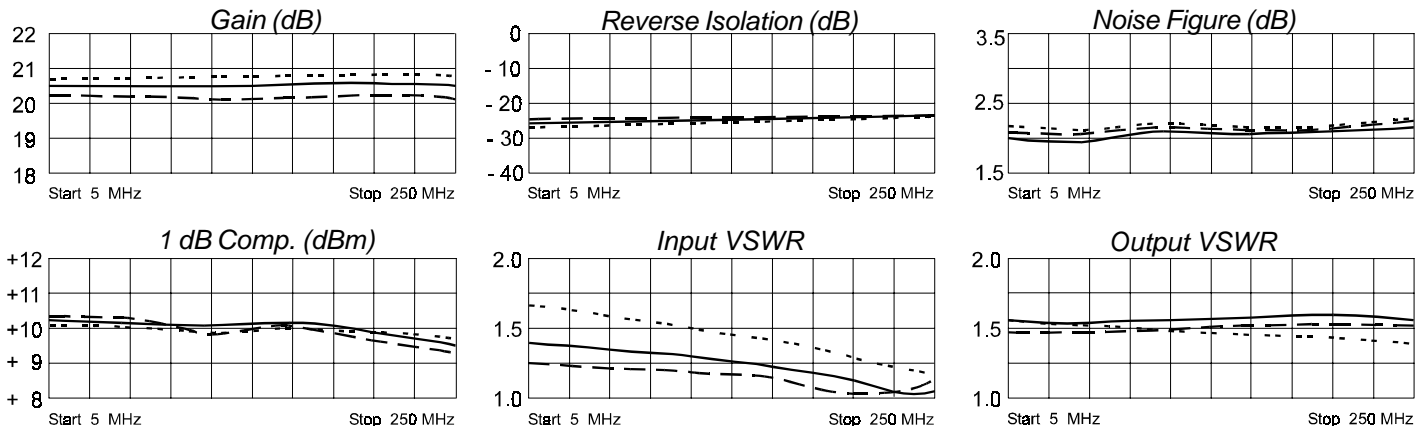
Typical Intermodulation Performance at 25 ° C

Second Order Harmonic Intercept Point +33 (Typ.)
 Second Order Two Tone Intercept Point +27 (Typ.)
 Third Order Two Tone Intercept Point +22 (Typ.)

Maximum Ratings

Ambient Operating Temperature -55°C to + 100 °C
 Storage Temperature -62°C to + 125 °C
 Case Temperature + 125 °C
 DC Voltage + 18 Volts
 Continuous RF Input Power + 13 dBm
 Short Term RF Input Power 50 Milliwatts
 (1 Minute Max.)
 Maximum Peak Power 0.5 Watt
 (3 µsec Max.)

Typical Performance Data



Legend ——— + 25 °C - - - - + 85 °C ······ -55 °C

Linear S-Parameters

FREQ. MHz	S11		S21		S12		S22	
	Mag	Deg	Mag	Deg	Mag	Deg	Mag	Deg
5	.17	-176	10.65	-178	.06	5	.21	-173
10	.16	179	10.63	179	.06	3	.21	-177
25	.16	173	10.62	173	.06	1	.21	-179
50	.15	165	10.61	164	.06	3	.21	-180
100	.13	148	10.61	148	.06	1	.21	-178
150	.10	134	10.62	132	.06	- 1	.22	180
200	.16	115	10.59	114	.07	- 0	.22	176
250	.01	- 34	10.58	97	.07	- 3	.23	169



2707 Black Lake Place, Philadelphia, PA 19154

TEL 215-464-4000 •••• FAX 215-464-4001 3/18/03